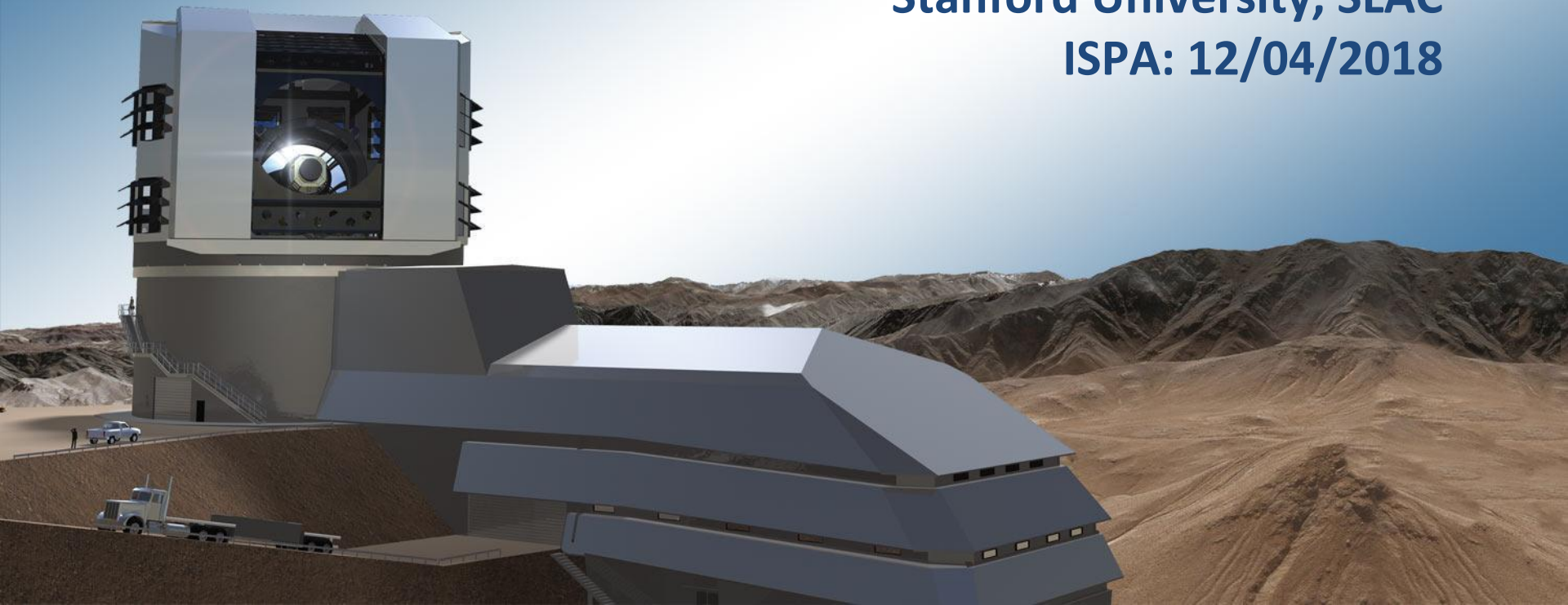
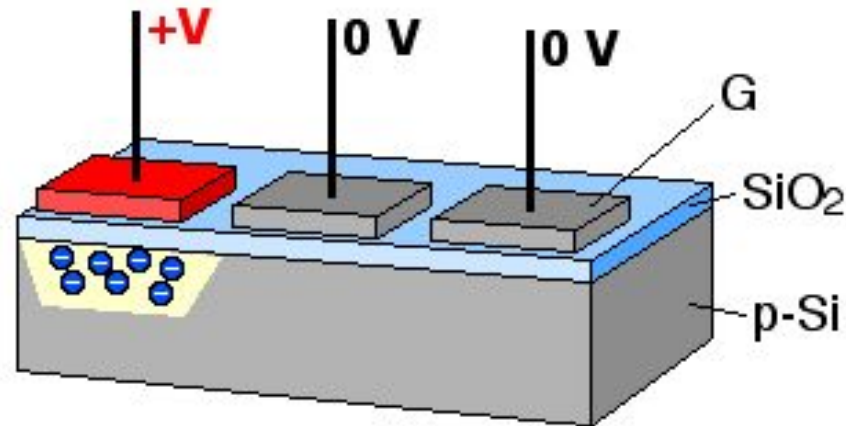




# Investigation of Deferred Charge Effects in LSST CCD Sensors

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ISPA: 12/04/2018





Credit: Michael Schmind

Each pixel-to-pixel transfer of charge is driven by:

- Self-induced drift/electrostatic repulsion at high signal
- Fringing fields at low signal
- Thermal diffusion in intermediate cases

Dependent on CCD temperature, clock timing and clock voltages.

## Effects dependent on number of transfers:

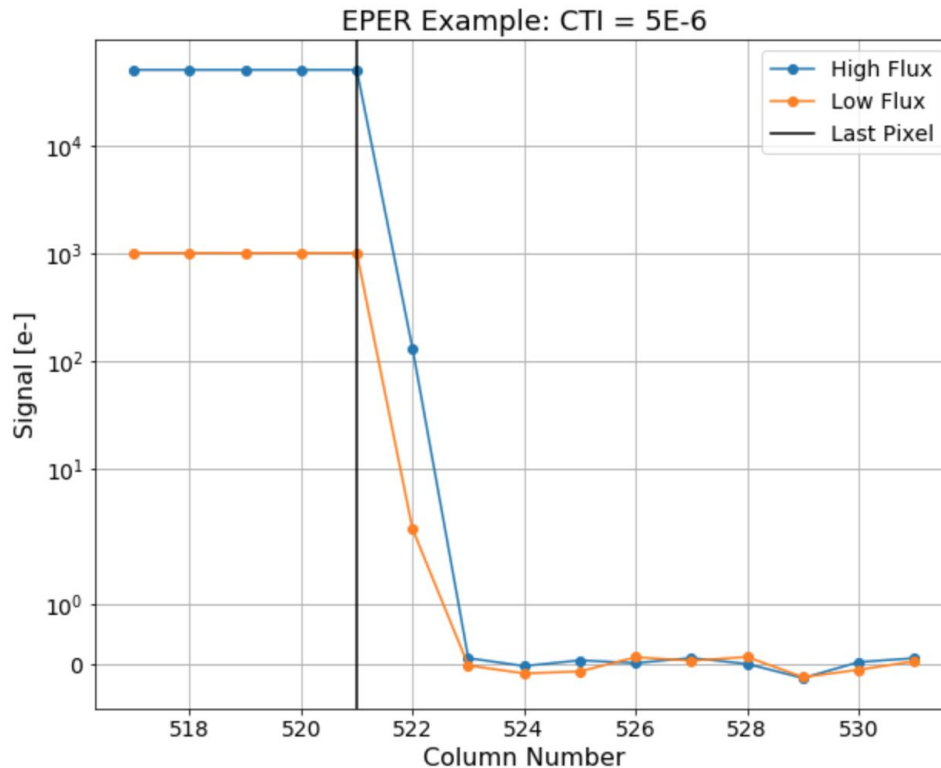
- Transfer due to self-induced drift, fringing fields, and diffusion
- Uniformly distributed single electron traps
  - Bulk traps
  - Radiation-induced traps

## Effects independent on number of transfers:

- Design traps - fixed charge loss of up to  $O(100)$  e-
- Process traps - fixed charge loss of  $O(10)$  e-
- Electronic effects
  - Drifting bias offset
  - Incomplete reset of the sense node

Charge Transfer Inefficiency (CTI) - ratio of electrons not transferred between two pixels, to the total electrons before the transfer.

Extended Pixel Edge Response (EPER) - measurement of deferred charge in the overscan pixel region, after a flat field image.



$$CTI = \frac{S_{\text{overscan}}}{N_T S_{\text{lastpixel}}}$$

# **ITL Serial Deferred Charge**

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LSST Serial CTI Specification:  $< 5E-6$

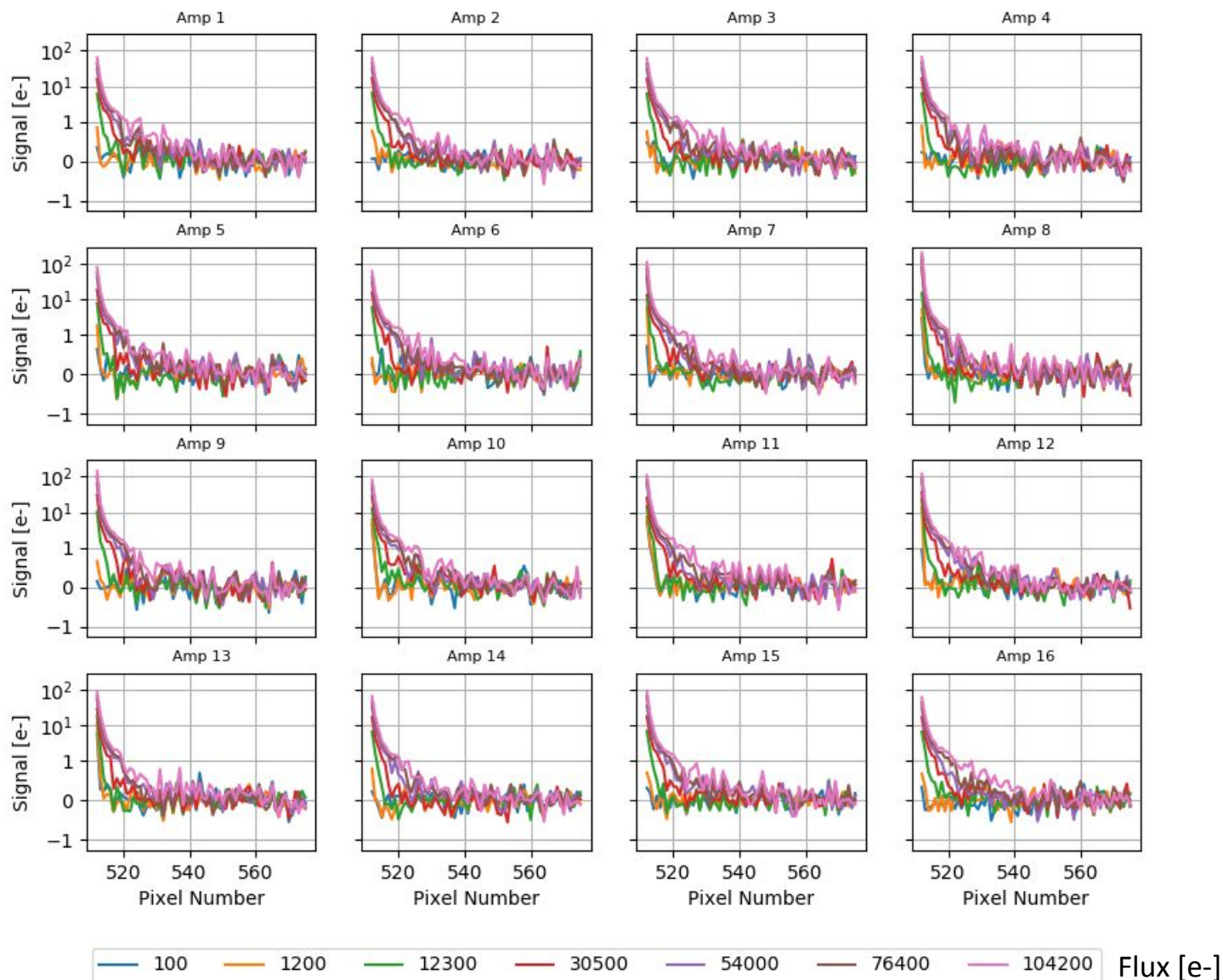
- Measured with EPER at 50,000 e- and 1,000 e-
- Additional analysis using Fe55 X-ray events
- Data from testing of assembled rafts

Serial Deferred Charge Results:

- Majority of channels meet LSST specifications, but...
  - Deferred charge seen in overscans at high flux
  - Deferred charge seen in Fe55 hits at low flux

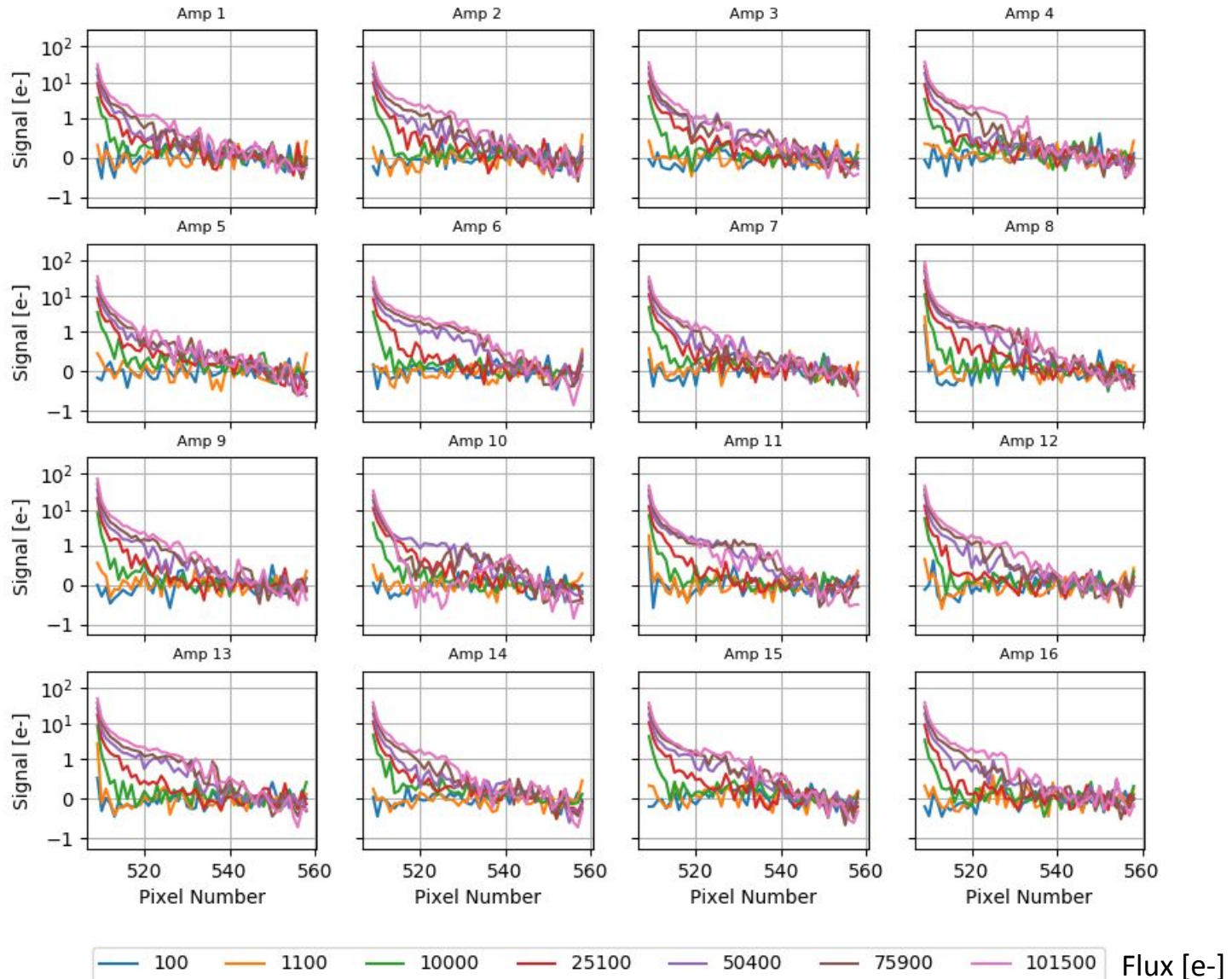
The following results are from one typical ITL production sensor.

# High Flux Deferred Charge



Overscan traces at different fluxes show deferred charge signal at high flux.

# High Flux Deferred Charge



Similar effect seen more strongly in vendor data.

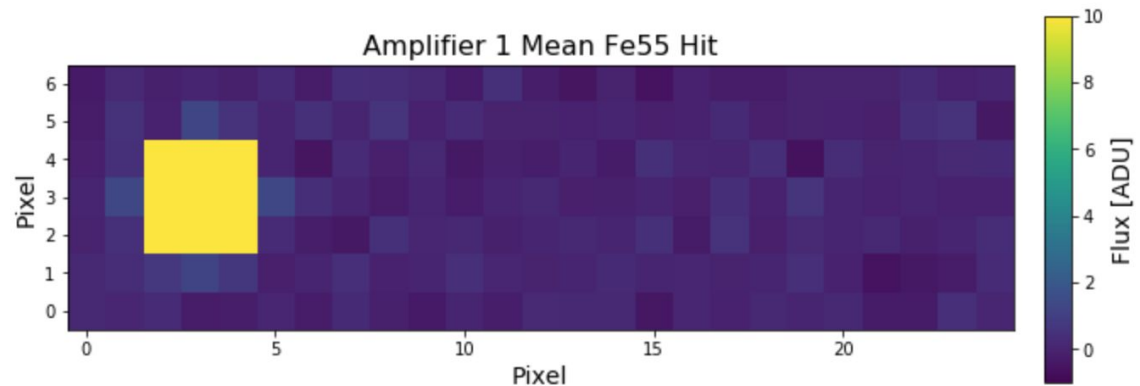


Analysis of Fe55 hits:

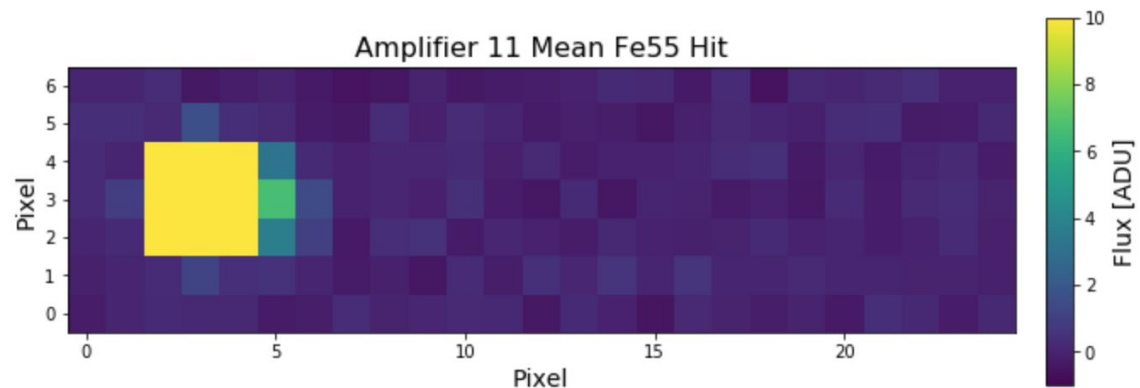
- Take many Fe55 acquisitions (w/ or w/out “sky” background)
- Aggregate identified Fe55 hits using a median stack

No sky background:

Nominal:

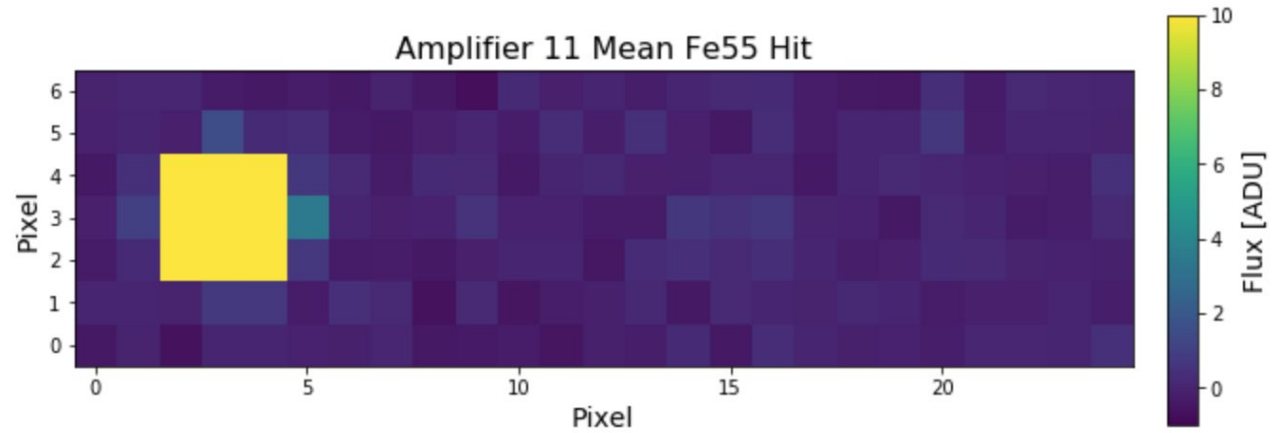


Affected:

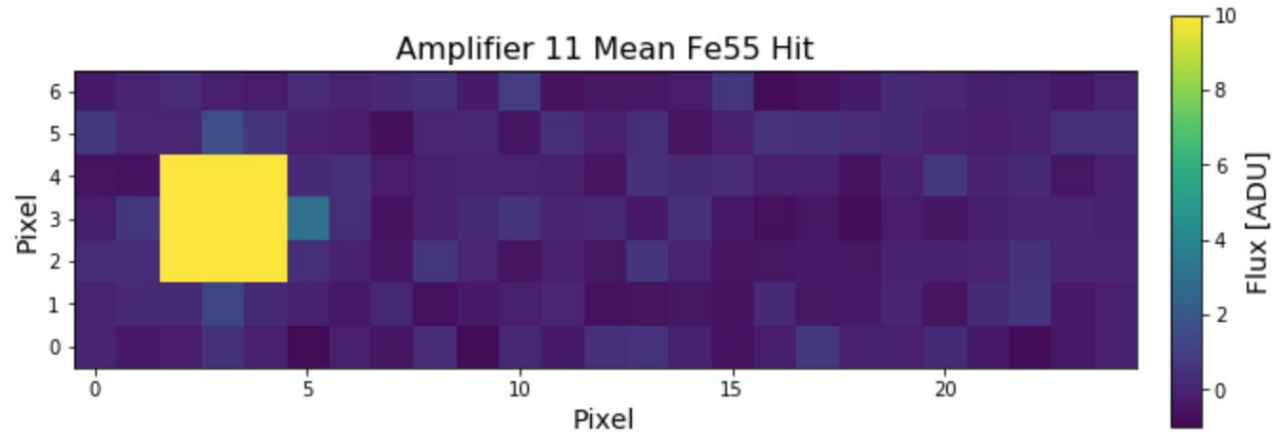


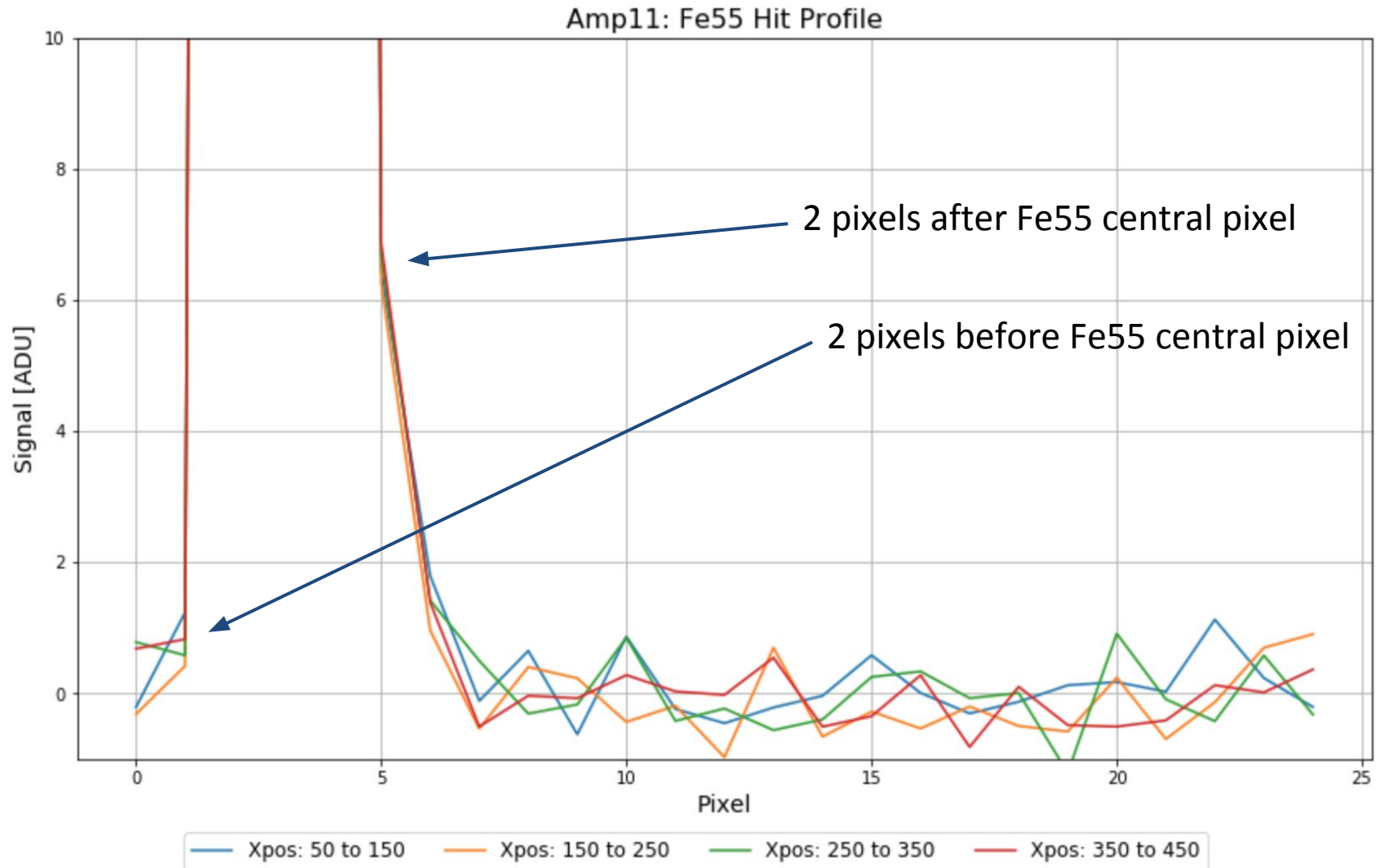
Effect is lessened with increasing “sky” background, but still present.

50 ADU :



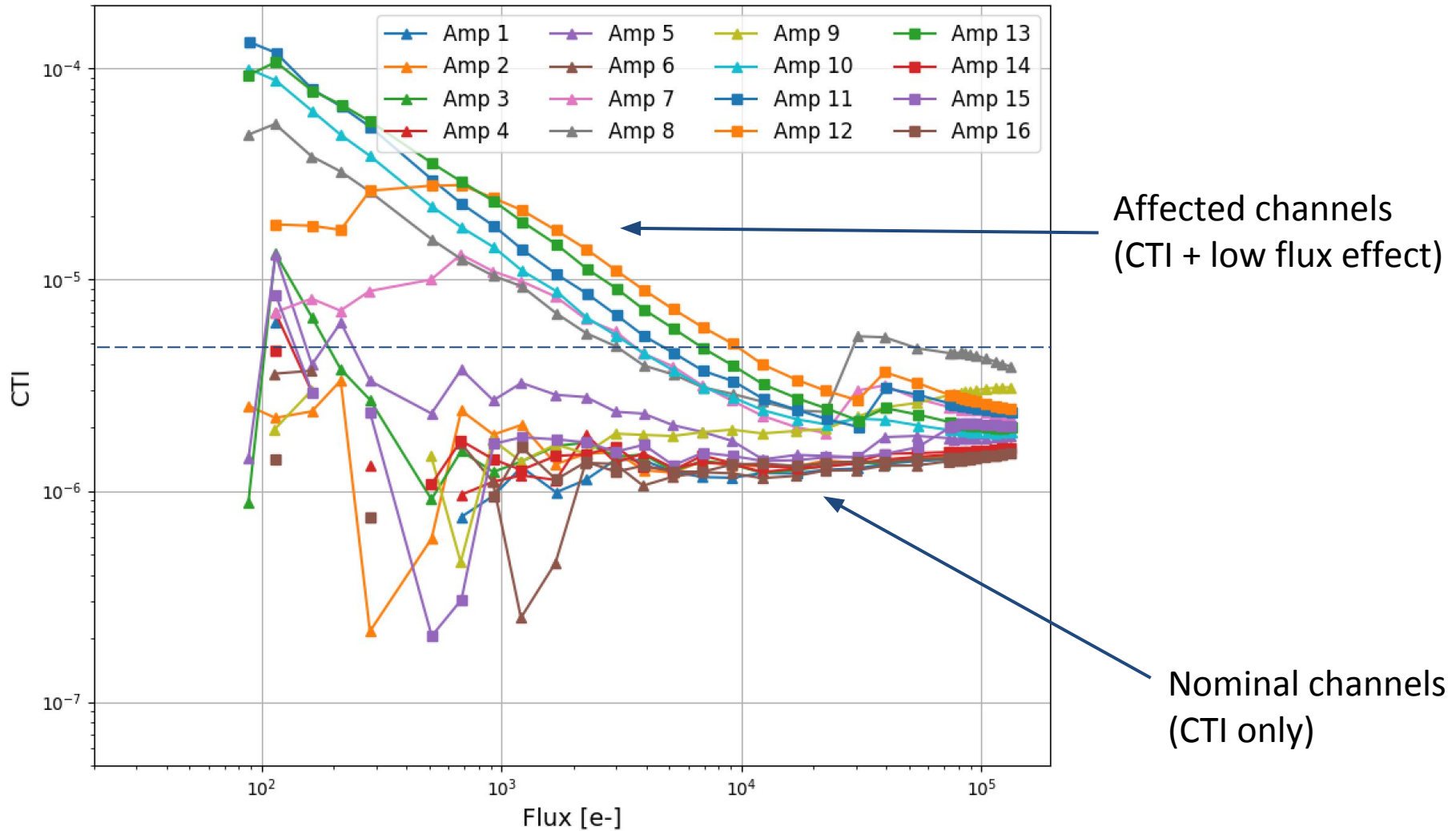
100 ADU:



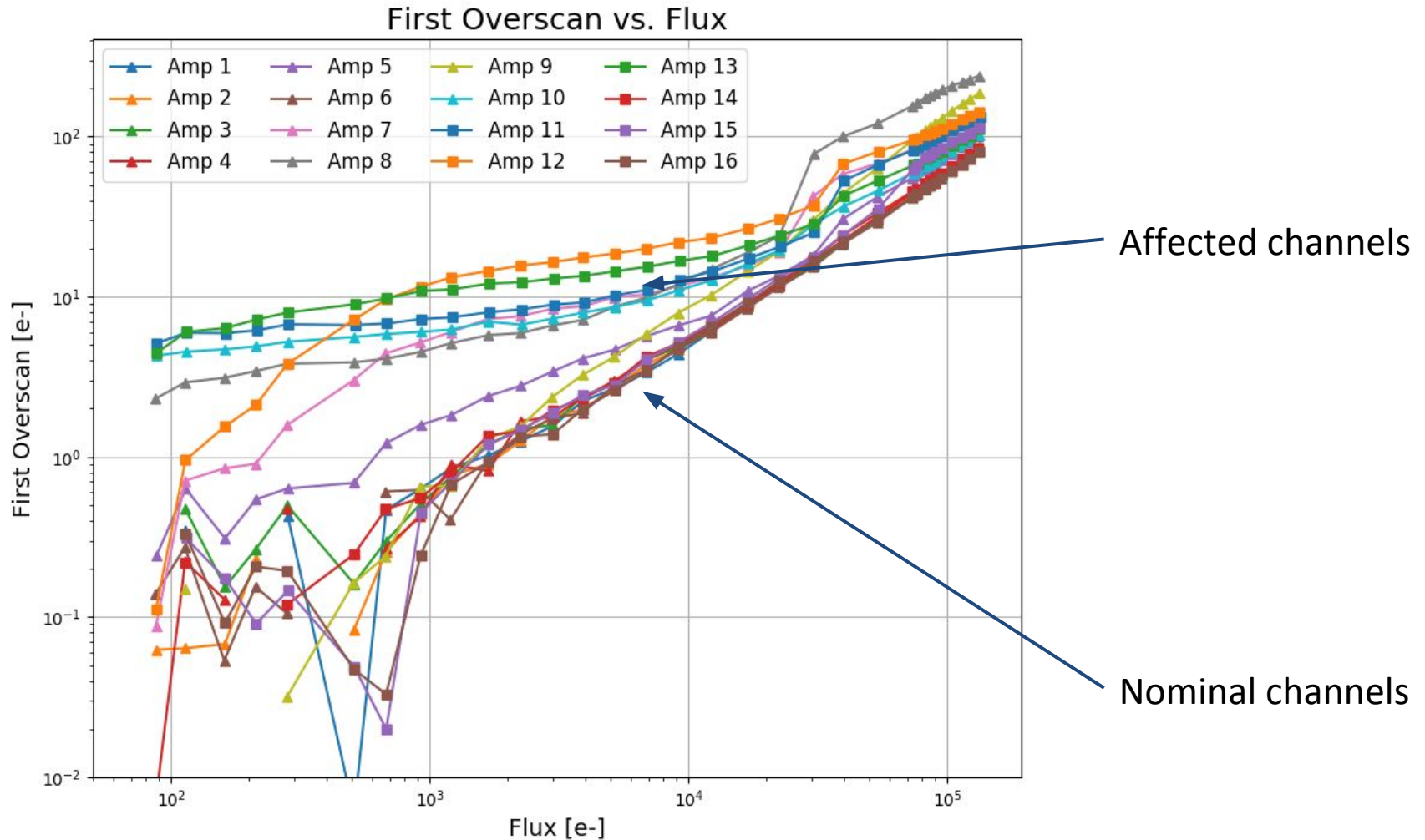


Coarse binning in the serial direction shows no dependence on number of transfers.

### CTI from EPER



This effect is reflected in EPER measurements as high CTI at low flux but is NOT necessarily dependent on # of transfers.



Signal in the first overscan provides evidence of a trap (<10 e-).

Two effects at work:

- All channels show deferred charge effects at high flux.
  - Flux dependent, exponential decay in overscans.
  - Present in both vendor (Archon controller) and raft data (REB controller).
- Some channels show deferred charge effects at low flux.
  - Non-proportional, very high CTI from EPER measurements.
  - Asymmetry in aggregated Fe55 profiles.
  - No dependence on number of transfers.
  - Evidence for a constant number of trapped electrons.

# Phenomenological Modeling

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Model the following deferred charge effects in separate regimes:

High Flux (>50,000 e-):

- Proportional CTI component
  - Assume constant or small linear dependence.
- Video channel electronic effect
  - Assume flux-dependent exponential decay.
  - Assume no dependence on number of transfers.
- Negligible contribution from low-flux component.

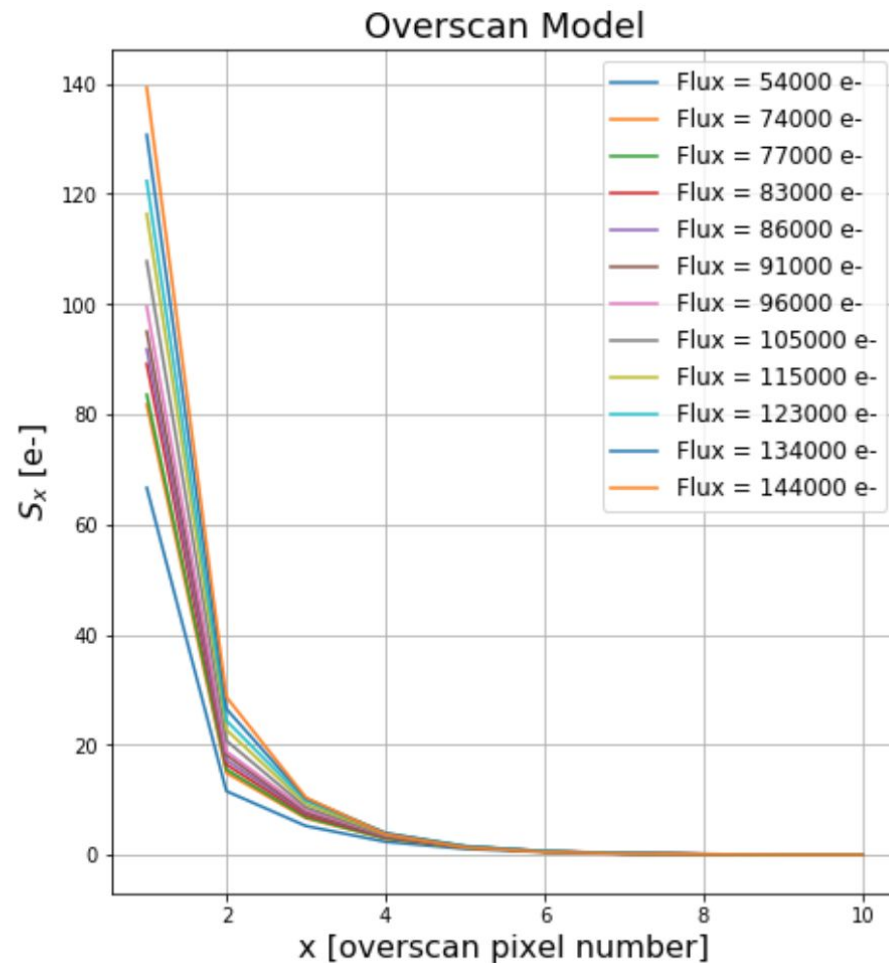
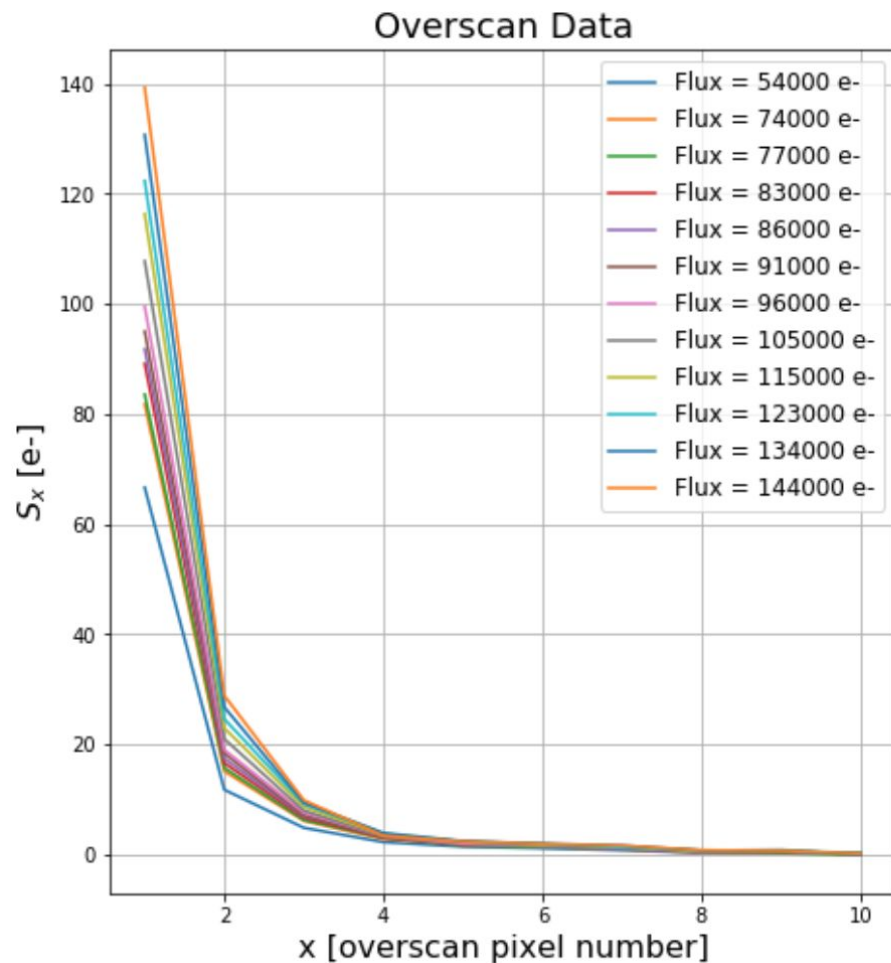
$$S(x, F) = A(F)e^{-x/\tau_{\text{high}}} + \text{CTI}^x N_T F$$

$x$  = overscan pixel number

$N_T$  = number of transfers

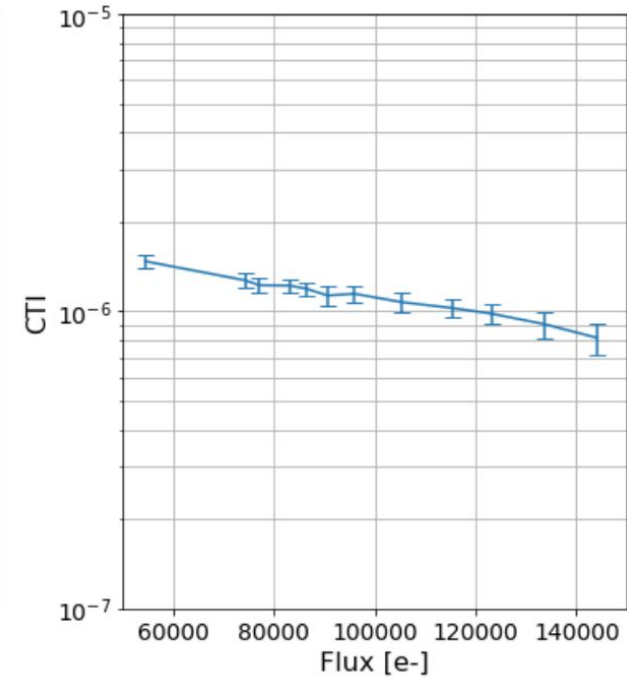
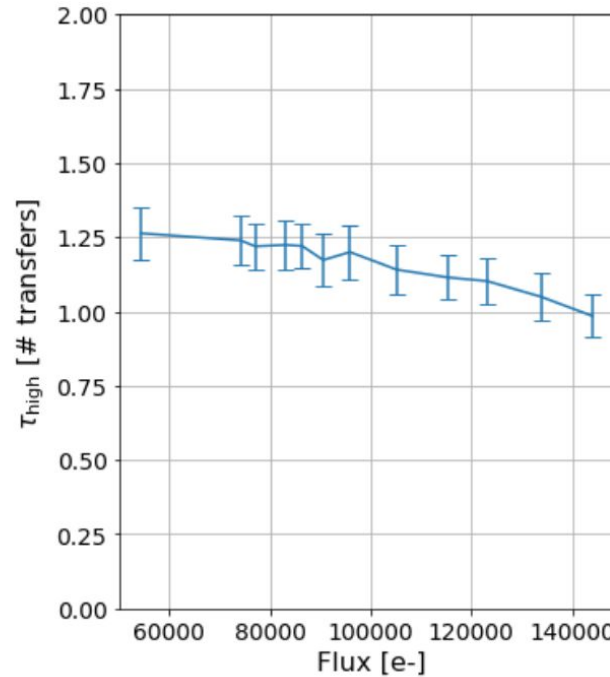
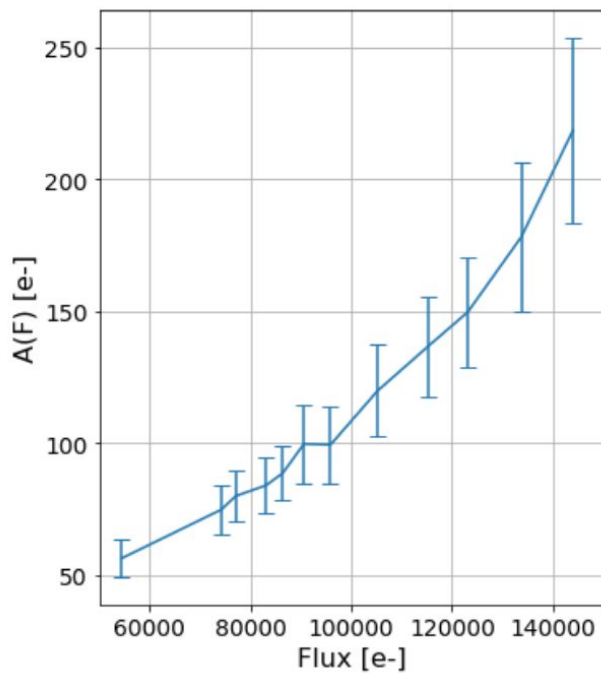
$F$  = Flux in last pixel





$$S(x, F) = A(F)e^{-x/\tau_{\text{high}}} + \text{CTI}^x N_T F$$

$$S(x, F) = A(F)e^{-x/\tau_{\text{high}}} + \text{CTI}^x N_T F$$



## High Flux Results:

- $A(F)$  increases with flux, though not a “simple” linear relation.
- Tau and CTI relatively stable over 60,000 e- to 140,000 e- range.

Low Flux (<3000 e-):

- Proportional CTI component
  - Contributes only to first overscan.
  - Calculated by extrapolating from high flux CTI results.
- Trap of O(10) e- at the start of the serial register.
  - Assume trapped charge is constant with flux in this regime.
  - Assume exponential release of trapped charge.
  - Assume no dependence on number of transfers.
- Negligible contribution from high-flux component.

$$S(x, F) = C_{\text{trap}} e^{-x/\tau_{\text{low}}} + \text{CTI}^x N_T F$$

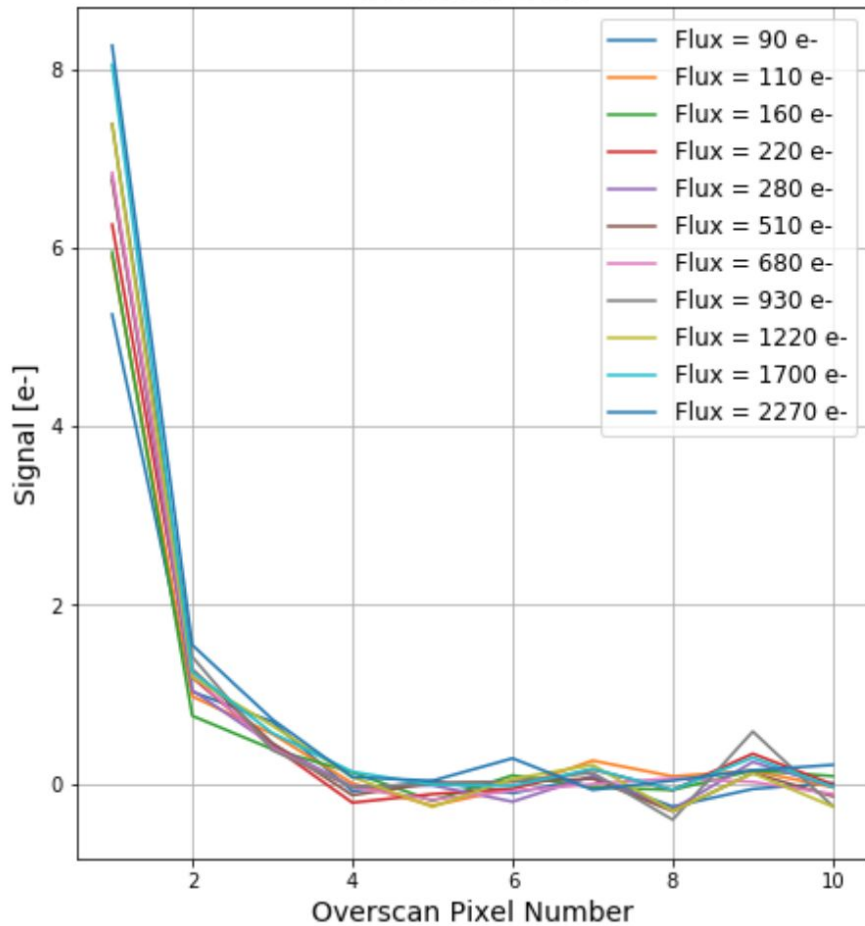
$x$  = overscan pixel number

$N_T$  = number of transfers

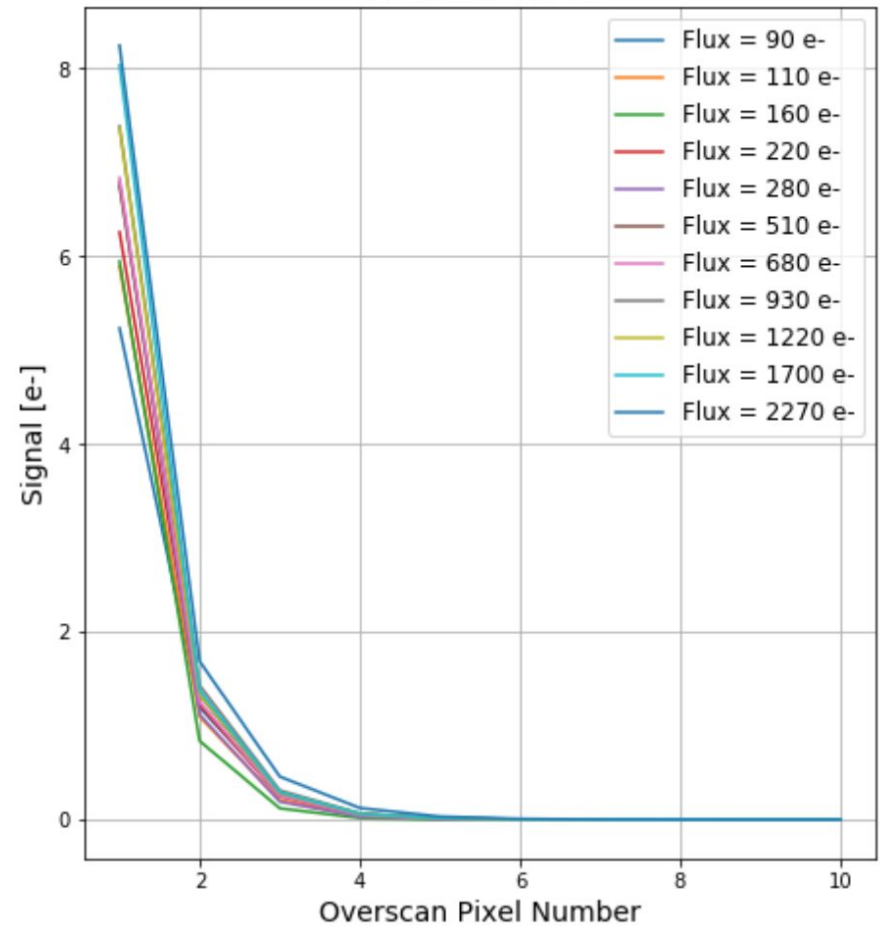
$F$  = Flux in last pixel

# Low Flux Exponential Model

Overscan Data

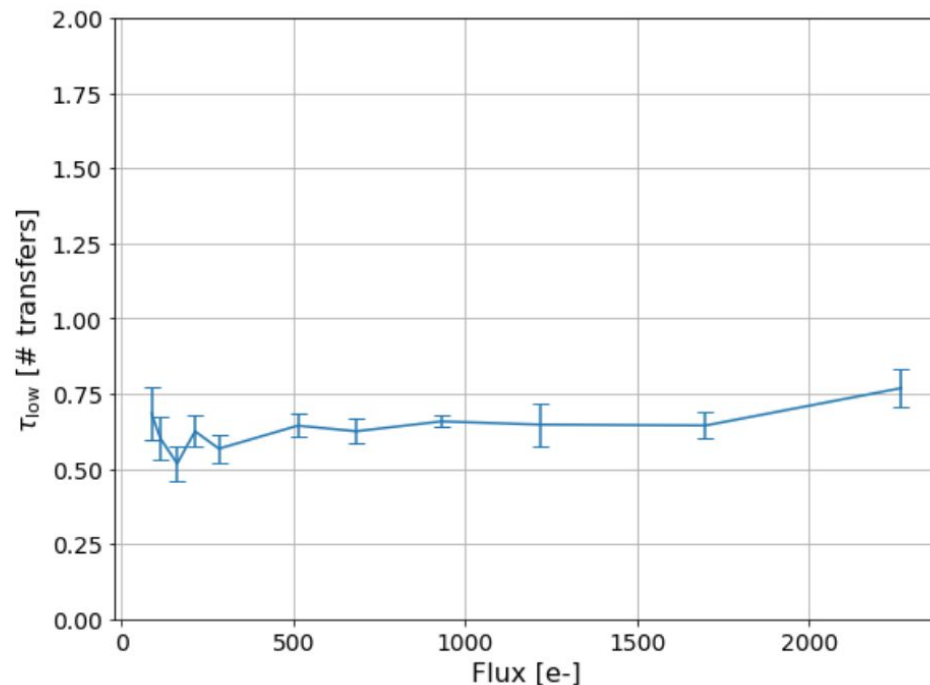
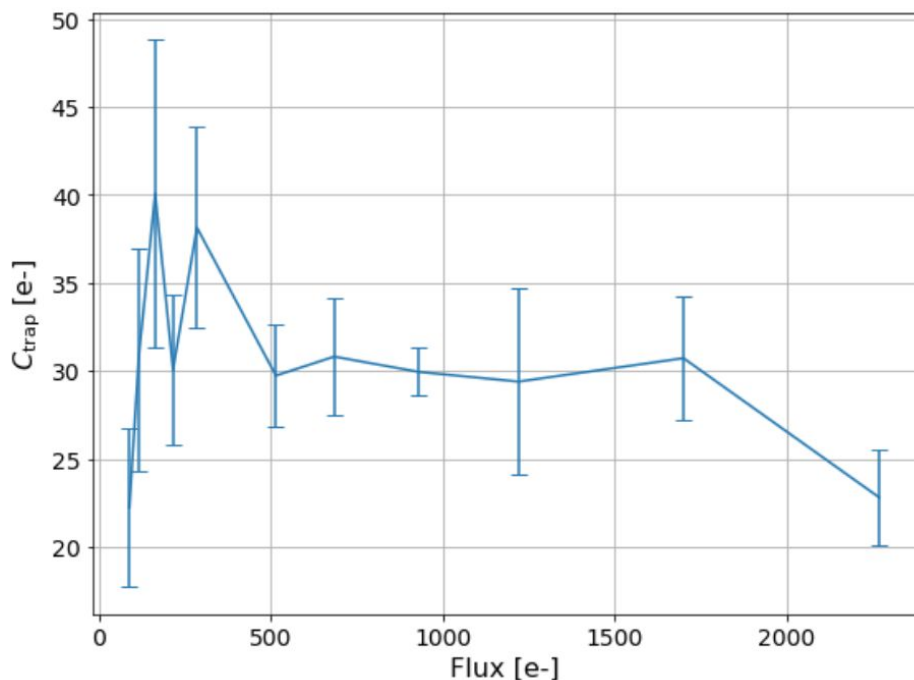


Overscan Model



$$S(x, F) = C_{\text{trap}} e^{-x/\tau_{\text{low}}} + \text{CTI}^x N_T F$$

$$S(x, F) = C_{\text{trap}} e^{-x/\tau_{\text{low}}} + \text{CTI}^x N_T F$$



## Low Flux Results:

- Fit results provide evidence for fast release trap.
  - Constant regime trapped charge between 100 e- and 1700 e-.
  - Fluxes not low enough to fully probe proportional trapped charge regime.

Encouraging results for 3-component model for overscan results:

$$S(x, F) = A(F)e^{-x/\tau_{\text{high}}} + C_{\text{trap}}e^{-x/\tau_{\text{low}}} + \text{CTI}^x N_T F$$

Next steps:

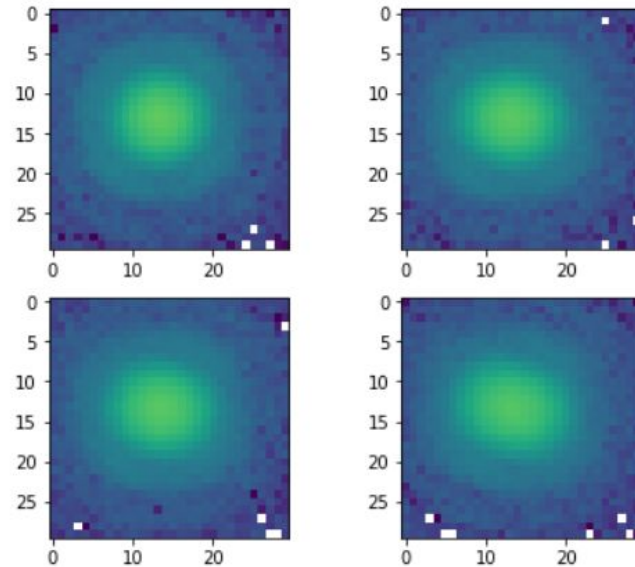
- Generalize for multiple amplifiers
- Joint fitting of all data to the model

What about realistic sources?

- Use model to simulate deferred charge effects on realistic sources and Fe55 X-rays events.
- Analyze images of realistic sources and compare with predictions from model.

# Backup Slides

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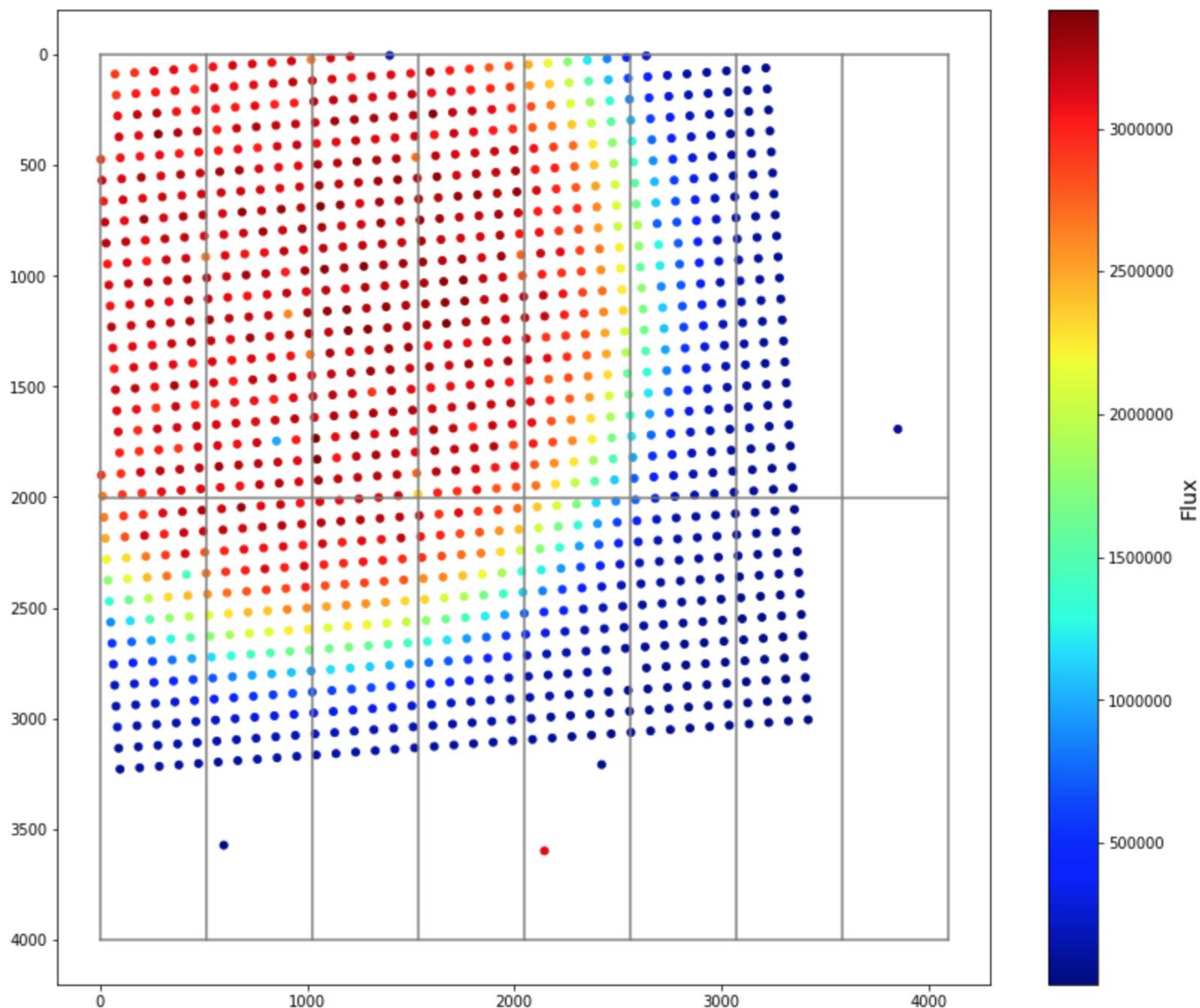


Measuring deferred charge in realistic sources:

1. Project grid of “spots” onto the CCD.
2. Use HSM for source moment calculations.
3. Study deferred charge effects as function of:
  - a. Position
  - b. Flux
  - c. “Sky” background

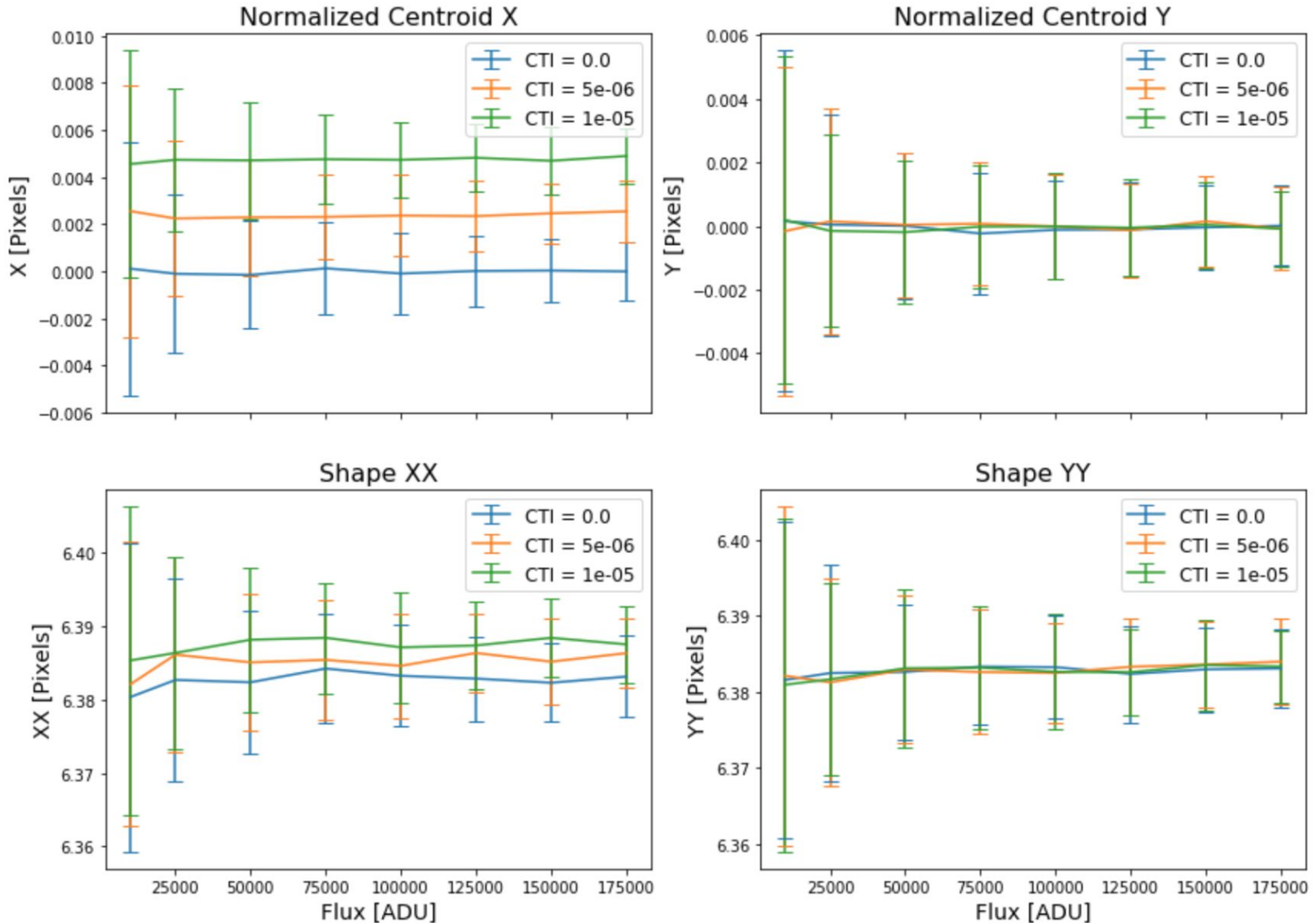


# Deferred Charge for Realistic Sources



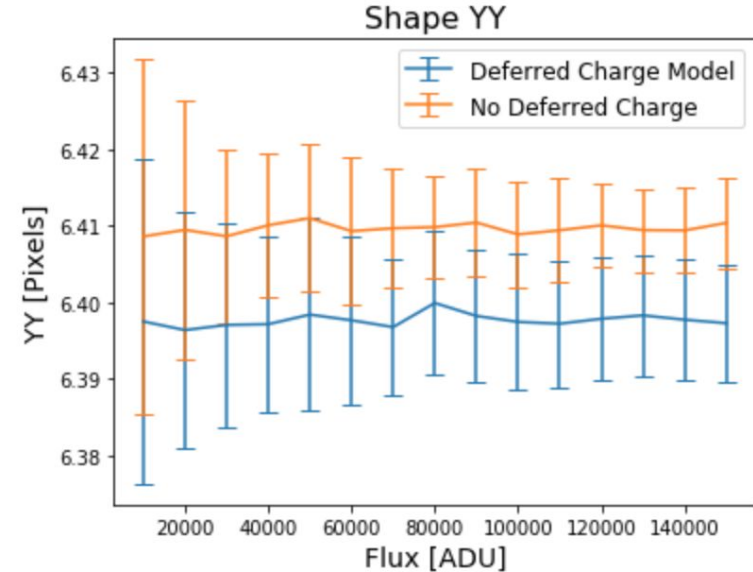
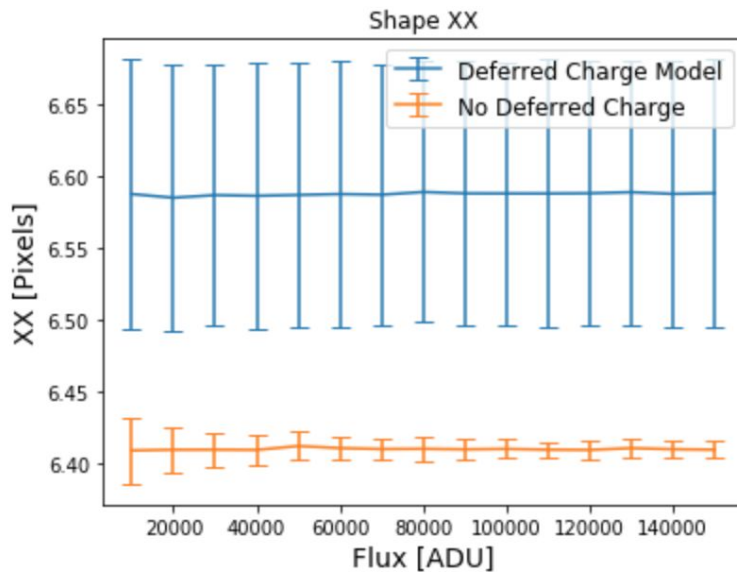
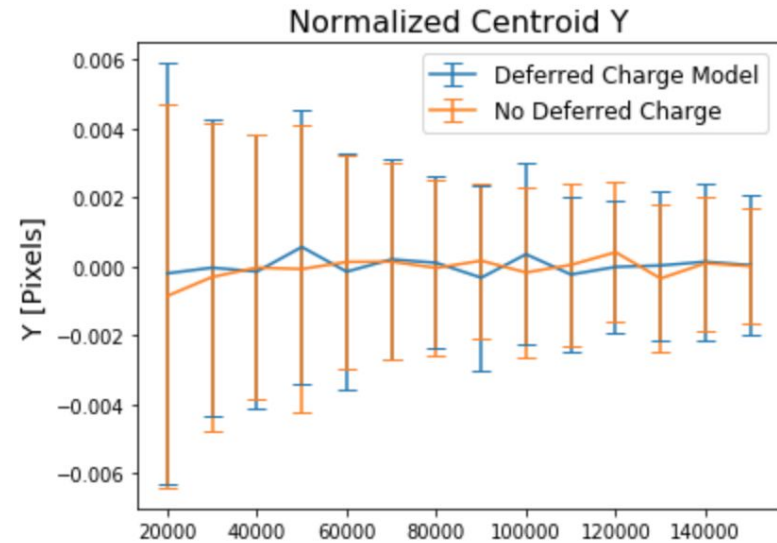
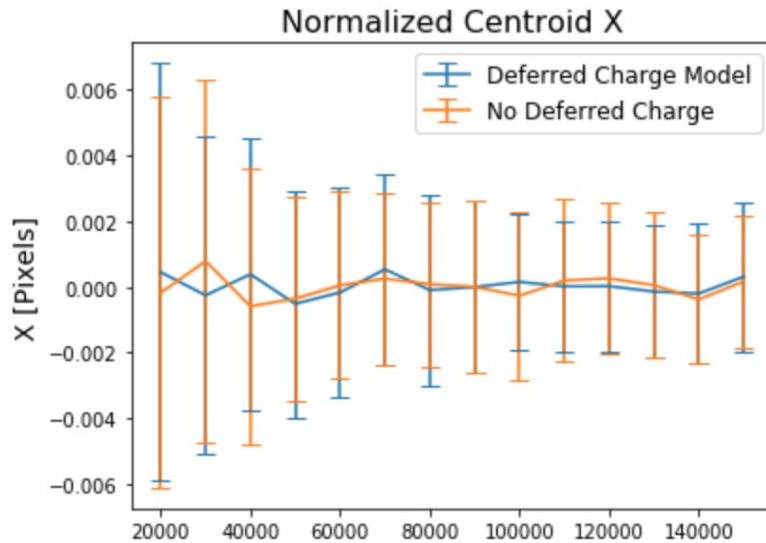
Real projected sources on LSST CCD.

# Deferred Charge for Realistic Sources



Simulated sources with only proportional CTI (500 transfers)

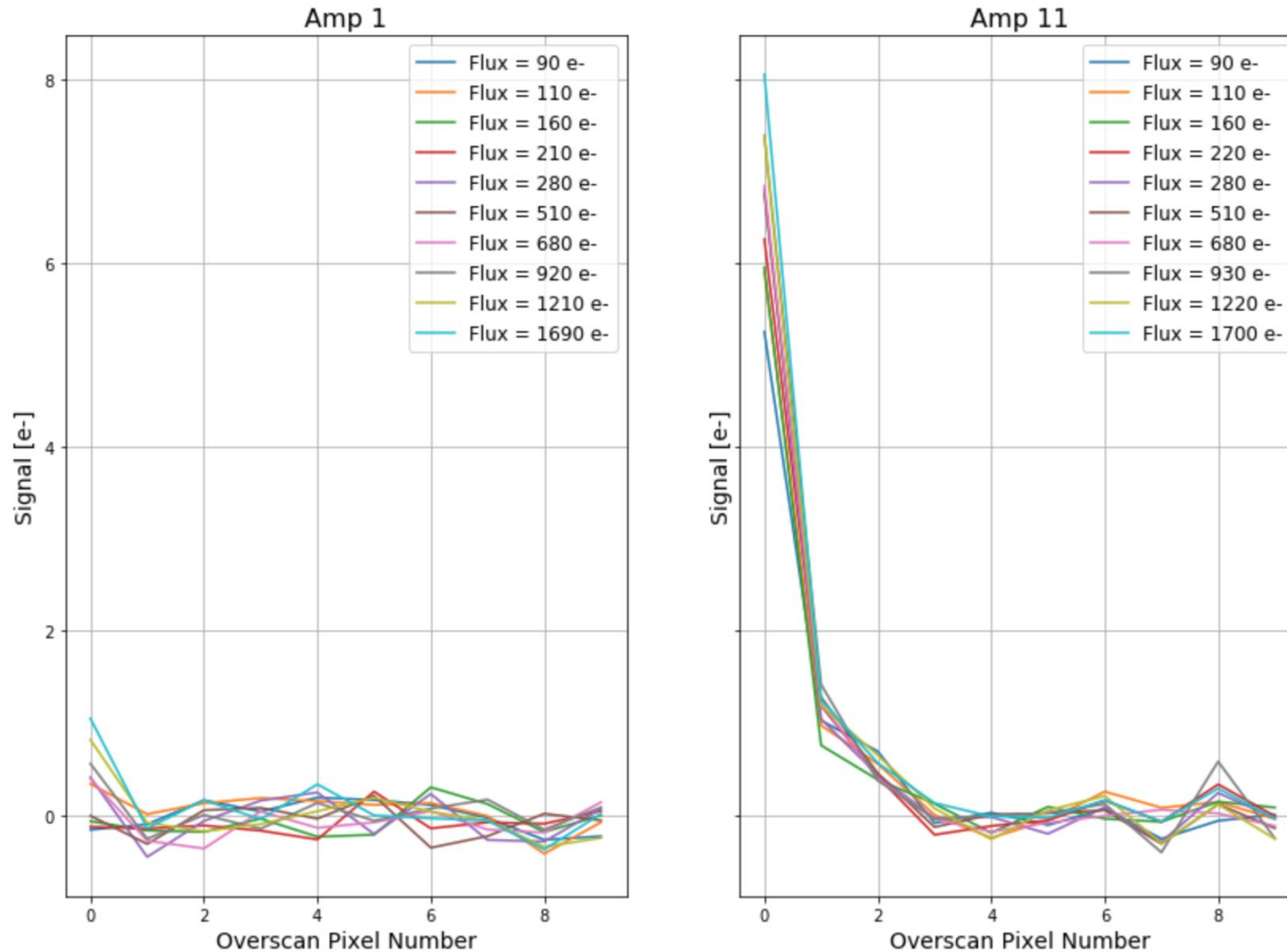
# Deferred Charge for Realistic Sources



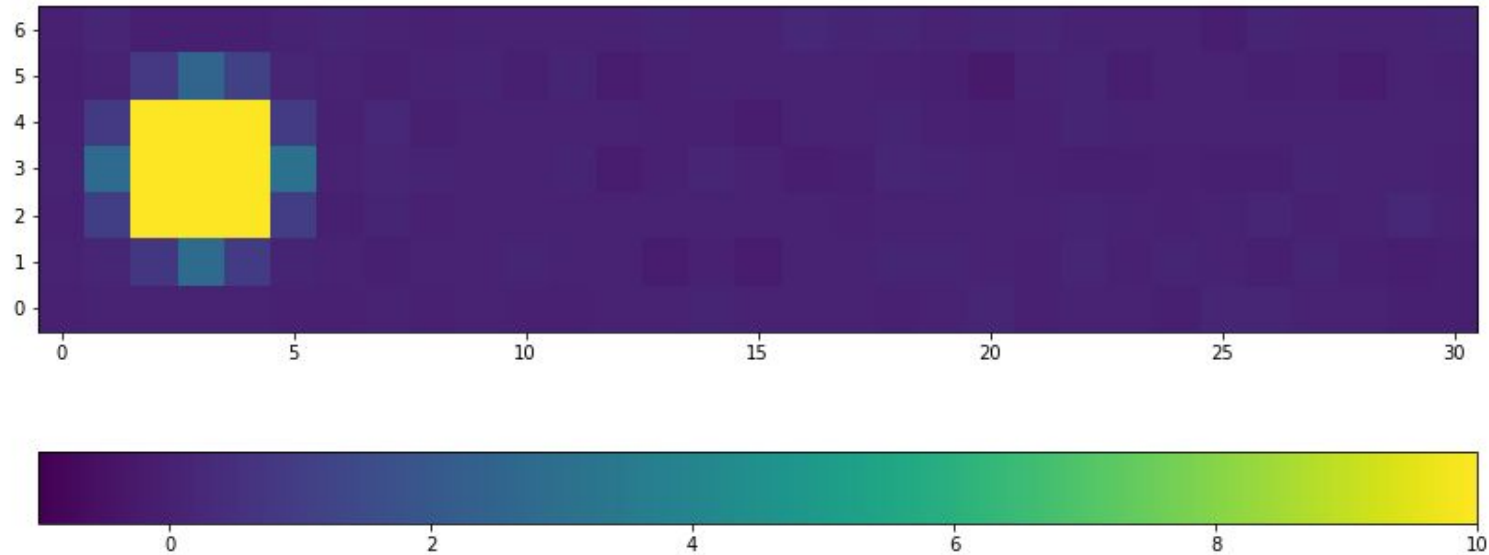
Simulated sources with high flux deferred charge model.

## Current Work:

- “Spot” projector has been built and tested at SLAC.
- Source moment measurements dominated by vibrations in the test set-up.
  - Characterizing effects of vibrations on moment results.
  - Minimization of vibrations by modifying the test set-up.



Comparison of two amplifiers, showing large CTI discrepancies at low flux.



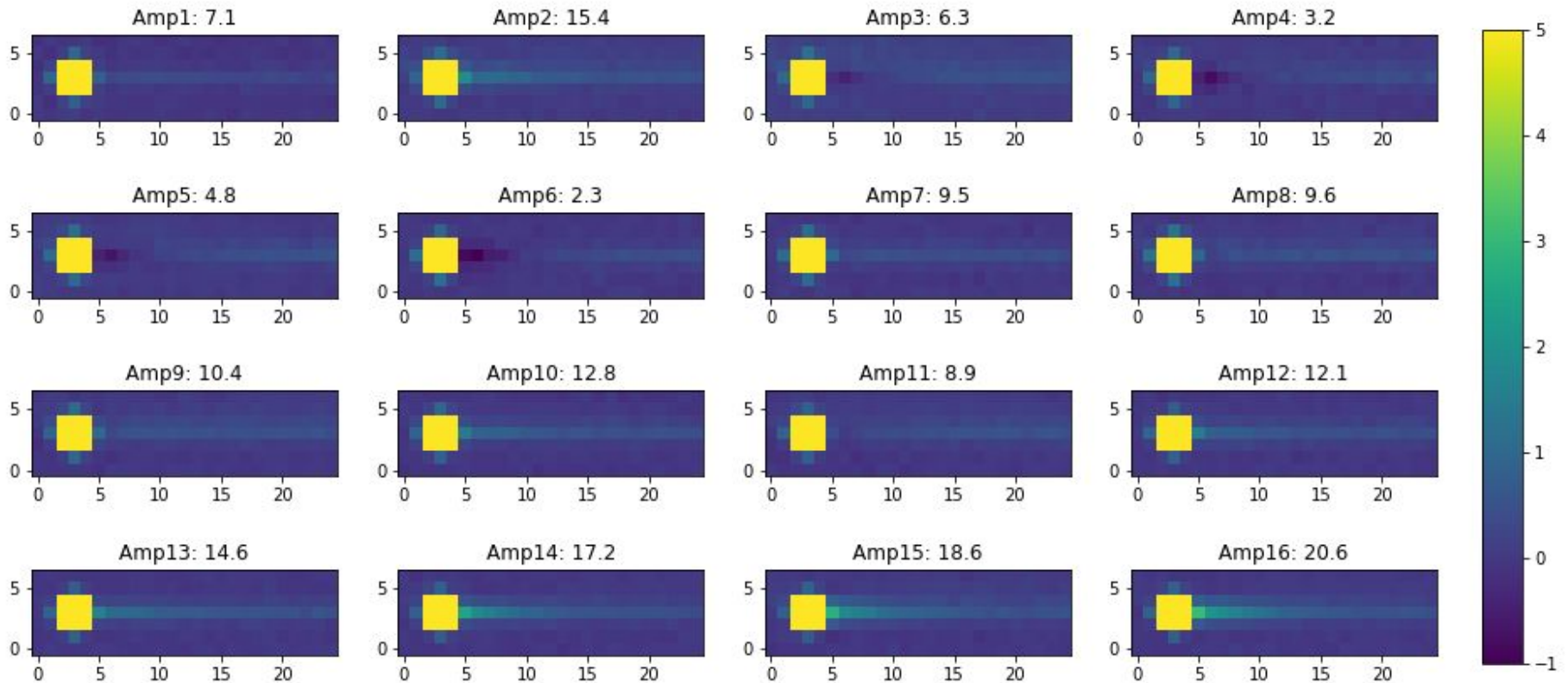
## High Flux Effects Only:

- Fit parameters extrapolated to low flux.
- Randomly simulated Fe55 hits across an amplifier.
- Applied deferred charge model (CTI+Exponential Decay).

Unable to recover Fe55 asymmetry and non-proportional CTI.

# **E2V Serial Deferred Charge**

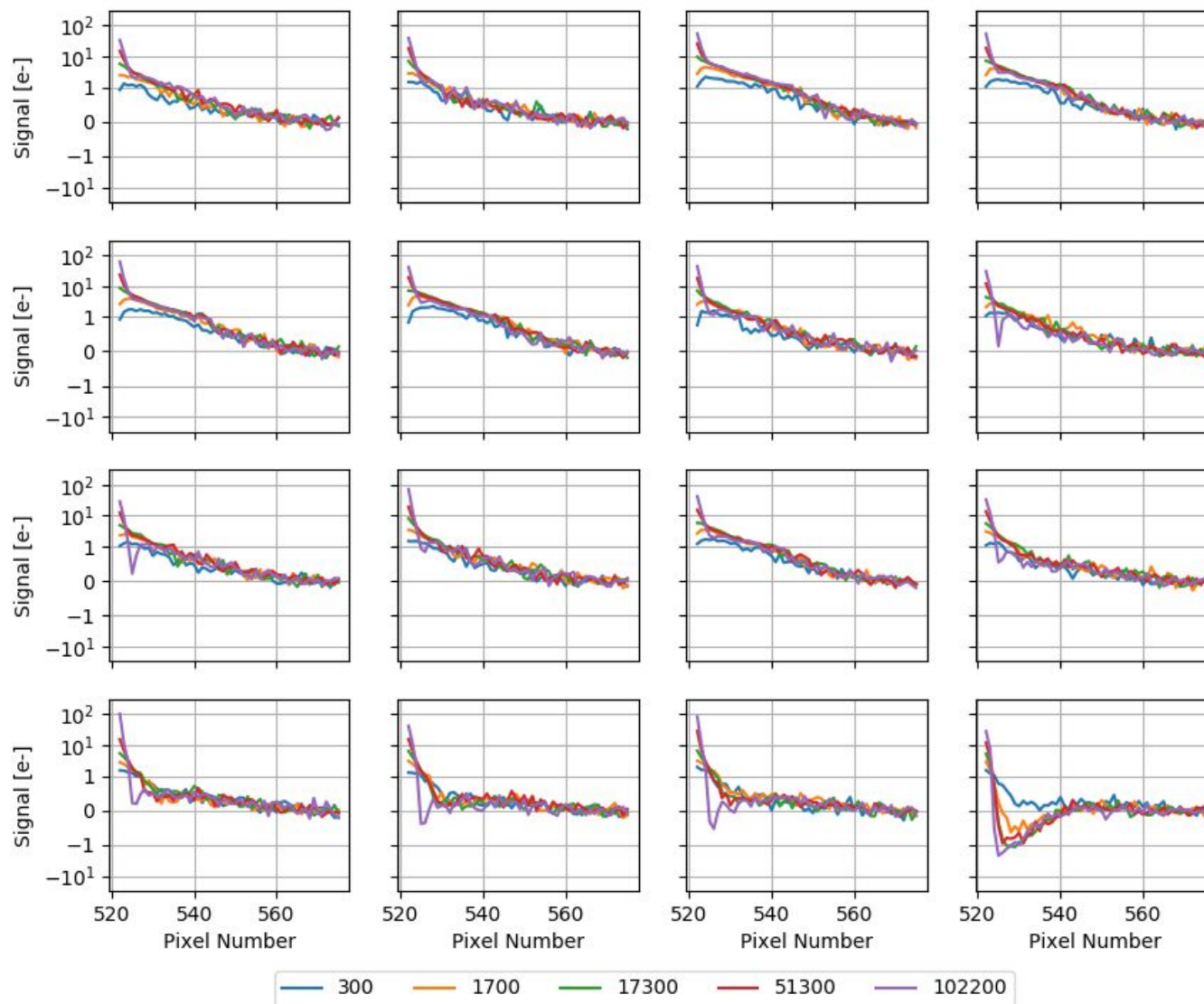
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Fe55 analysis:

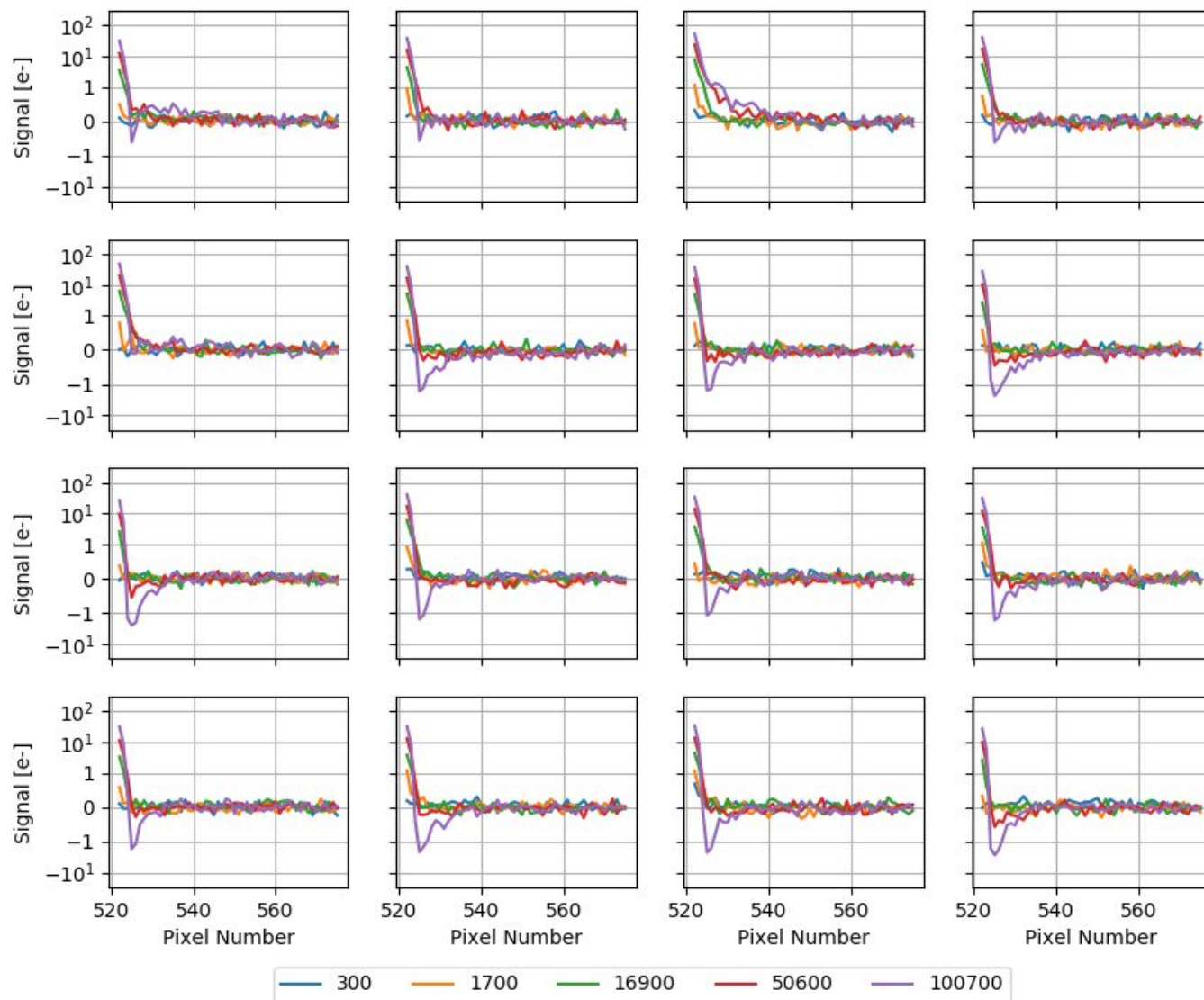
- No position dependence.
- Large affect even at low fluxes.





Trailing charge (no flux dependence) seen in E2V sensors at BNL.

# Overscan Traces (New Operating Conditions)



Effect disappears with increasing reset gate voltage swing.